

# MECHANICAL CASE OUTLINE

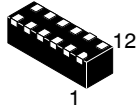
## PACKAGE DIMENSIONS

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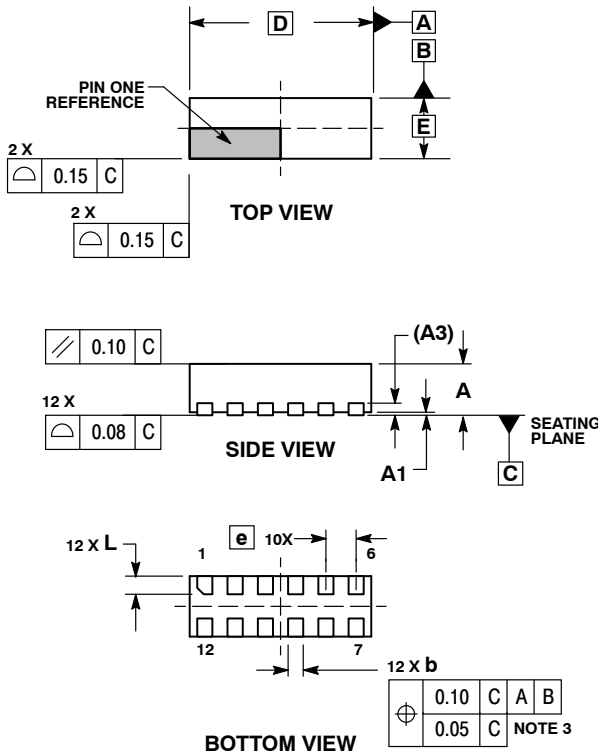


### 12 PIN WDFN 3.0x1.0, 0.5P CASE 485AG-01 ISSUE A

DATE 31 MAR 2006



SCALE 4:1

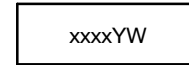


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION b APPLIES TO TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

MILLIMETERS		
DIM	MIN	MAX
A	0.70	0.80
A1	0.00	0.05
A3	0.20	REF
b	0.18	0.30
D	3.00	BSC
E	1.00	BSC
e	0.50	BSC
L	0.20	0.40

### GENERIC MARKING DIAGRAM\*



1

- xxxx = Specific Device Code
- Y = Year
- W = Work Week
- G or ■ = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking.  
Pb-Free indicator, "G" or microdot "■", may or may not be present.

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<b>DESCRIPTION:</b>	<b>12 PIN WDFN 3.0X1.0, 0.5 MM PITCH</b>	<b>PAGE 1 OF 1</b>

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